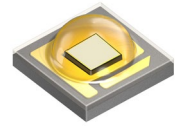


# LV CQBP

## OSLON® Signal

The OSLON® Signal combine a compact size (small footprint: 3x3mm) with a high efficiency and a electrically insulated thermal pad.



## Applications

- Traffic Lights

## Features:

- Package: SMD ceramic package with silicone lens
- Chip technology: UX:3
- Typ. Radiation: 120°
- Color:  $\lambda_{\text{dom}} = 505 \text{ nm}$  (• verde)
- Corrosion Robustness Class: 3B
- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)

## Ordering Information

Type	Luminous Flux <sup>1)</sup> $I_F = 350 \text{ mA}$ $\Phi_V$	Ordering Code
LV CQBP-JZLX-BD-1	61 ... 130 lm	Q65111A4876

## Maximum Ratings

Parameter	Symbol		Values
Operating Temperature	$T_{op}$	min.	-40 °C
		max.	120 °C
Storage Temperature	$T_{stg}$	min.	-40 °C
		max.	120 °C
Junction Temperature	$T_j$	max.	150 °C
Junction Temperature for short time applications*	$T_j$	max.	175 °C
Forward current $T_s = 25\text{ °C}$	$I_F$	min.	30 mA
		max.	1000 mA
Surge Current $t \leq 10\ \mu\text{s}; D = 0.005; T_s = 25\text{ °C}$	$I_{FS}$	max.	2000 mA
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	$V_{ESD}$		8 kV
Reverse current <sup>2)</sup>	$I_R$	max.	50 mA

\* The median lifetime (L70/B50) for  $T_j = 175\text{ °C}$  is 100h.

## Characteristics

$I_F = 350 \text{ mA}$ ;  $T_s = 25 \text{ °C}$

Parameter	Symbol		Values
Peak Wavelength	$\lambda_{\text{peak}}$	typ.	503 nm
Dominant Wavelength <sup>3)</sup> $I_F = 350 \text{ mA}$	$\lambda_{\text{dom}}$	min.	498 nm
		typ.	505 nm
		max.	512 nm
Spectral Bandwidth at 50% $I_{\text{rel,max}}$	$\Delta\lambda$	typ.	30 nm
Viewing angle at 50% $I_V$	$2\varphi$	typ.	130 °
Forward Voltage <sup>4)</sup> $I_F = 350 \text{ mA}$	$V_F$	min.	2.75 V
		typ.	3.25 V
		max.	3.50 V
Reverse voltage (ESD device)	$V_{\text{RES D}}$	min.	5 V
Reverse voltage <sup>2)</sup> $I_R = 5 \text{ mA}$	$V_R$	max.	7 V
Real thermal resistance junction/solderpoint <sup>5)</sup>	$R_{\text{thJS real}}$	typ.	9.6 K / W
		max.	10.8 K / W
Electrical thermal resistance junction/solderpoint <sup>5)</sup> with efficiency $\eta_e = 20 \%$	$R_{\text{thJS elec.}}$	typ.	7.7 K / W
		max.	8.6 K / W

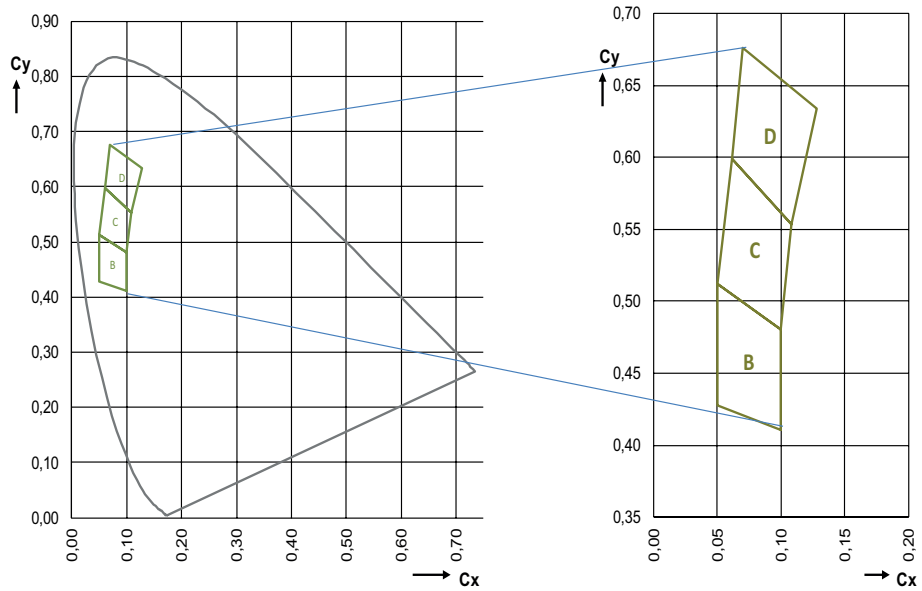
## Brightness Groups

Group	Luminous Flux <sup>1)</sup> $I_F = 350 \text{ mA}$ min. $\Phi_V$	Luminous Flux <sup>1)</sup> $I_F = 350 \text{ mA}$ max. $\Phi_V$	Luminous Intensity <sup>6)</sup> $I_F = 350 \text{ mA}$ typ. $I_v$
JZ	61 lm	71 lm	22 cd
KX	71 lm	82 lm	25 cd
KY	82 lm	97 lm	30 cd
KZ	97 lm	112 lm	35 cd
LX	112 lm	130 lm	40 cd

## Forward Voltage Groups

Group	Forward Voltage <sup>4)</sup> $I_F = 350 \text{ mA}$ min. $V_F$	Forward Voltage <sup>4)</sup> $I_F = 350 \text{ mA}$ max. $V_F$
8E	2.75 V	3.00 V
8F	3.00 V	3.25 V
8G	3.25 V	3.50 V

## Chromaticity Coordinate Groups <sup>7)</sup>



### Chromaticity Coordinate Groups

Group	Cx	Cy	Group	Cx	Cy	Group	Cx	Cy
B	0.0500	0.4276	C	0.0500	0.5120	D	0.0615	0.5985
	0.0500	0.5120		0.0615	0.5985		0.0700	0.6756
	0.1000	0.4805		0.1080	0.5532		0.1280	0.6334
	0.1000	0.4110		0.1000	0.4805		0.1080	0.5532

---

## Group Name on Label

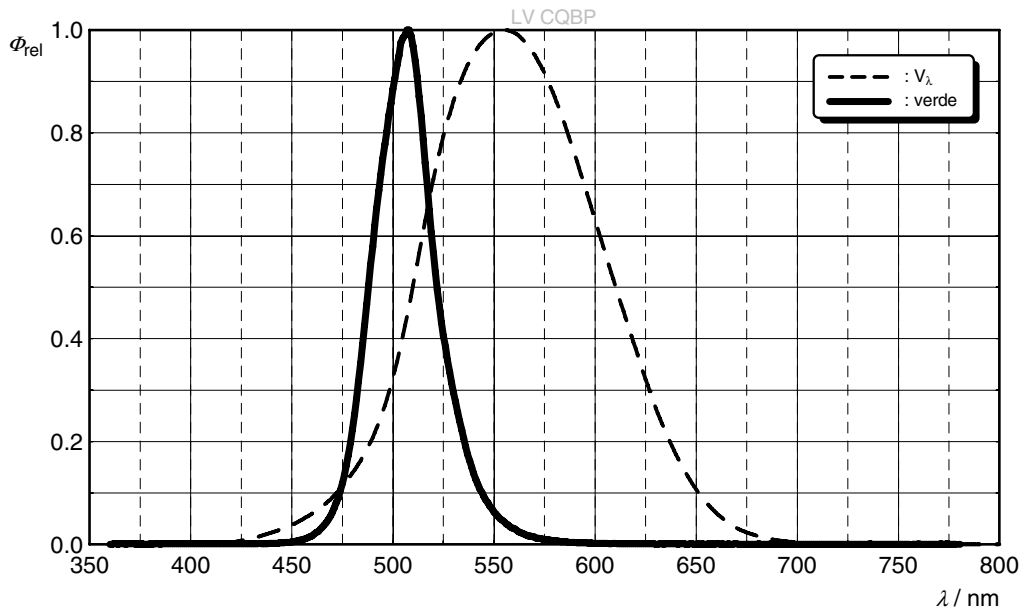
**Example: JZ-B-8E**

Brightness	Color Chromaticity	Forward Voltage
JZ	B	8E

---

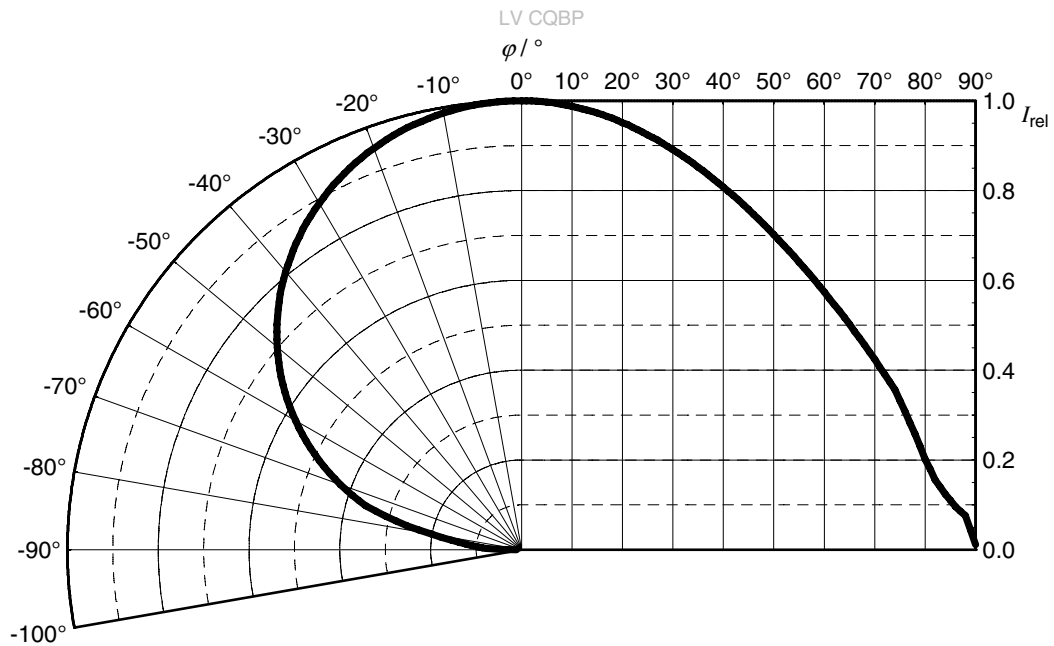
### Relative Spectral Emission <sup>6)</sup>

$\Phi_{rel} = f(\lambda); I_F = 350 \text{ mA}; T_S = 25 \text{ }^\circ\text{C}$



### Radiation Characteristics <sup>6)</sup>

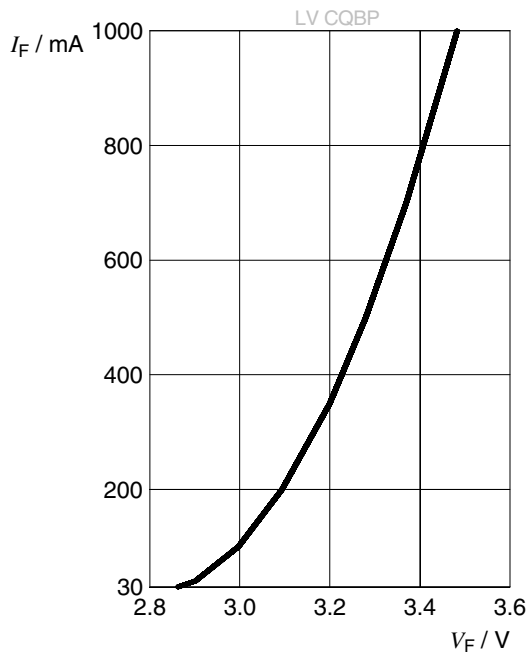
$I_{rel} = f(\phi); T_S = 25 \text{ }^\circ\text{C}$



Not for new design

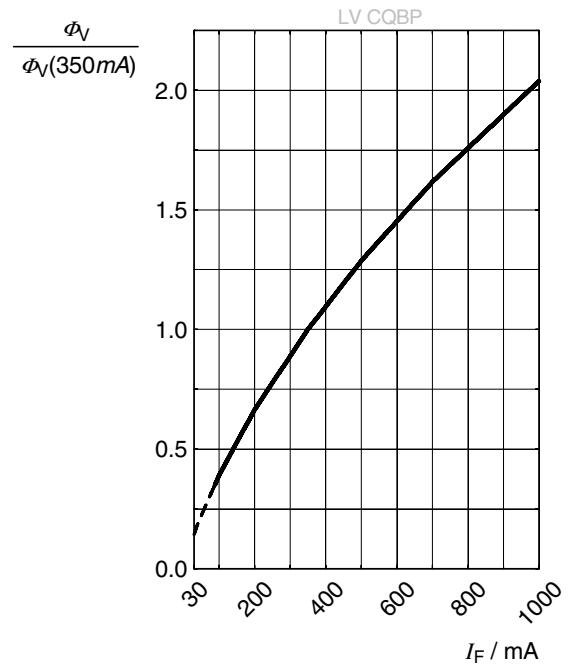
**Forward current** <sup>6)</sup>

$I_F = f(V_F); T_S = 25\text{ °C}$



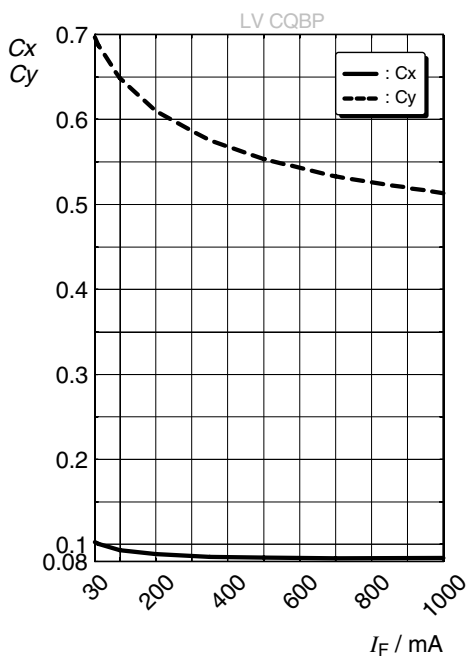
**Relative Luminous Flux** <sup>6), 8)</sup>

$\Phi_V / \Phi_V(350\text{ mA}) = f(I_F); T_S = 25\text{ °C}$



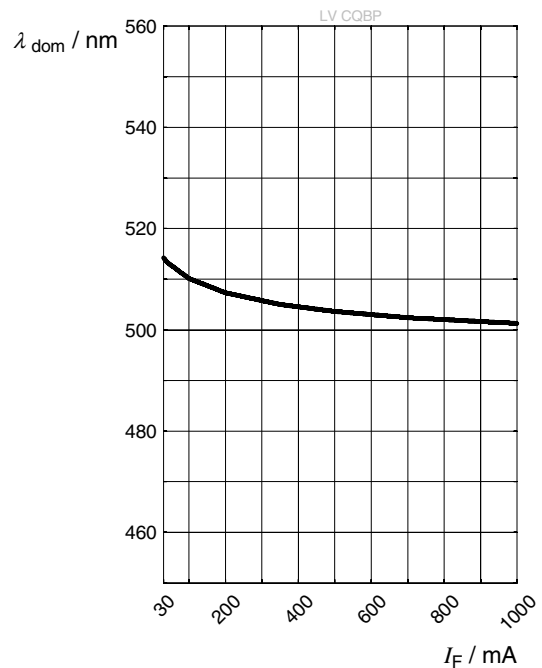
**Chromaticity Coordinate Shift** <sup>6)</sup>

$C_x, C_y = f(I_F); T_S = 25\text{ °C}$



**Dominant Wavelength** <sup>6)</sup>

$\lambda_{\text{dom}} = f(I_F); T_S = 25\text{ °C}$

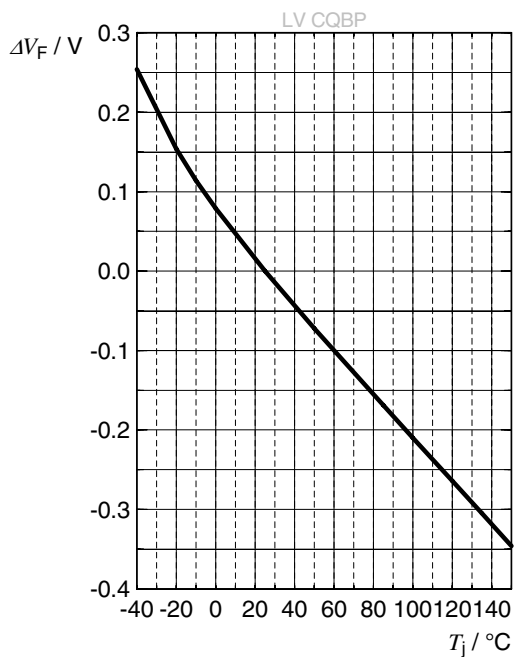


Not for new design



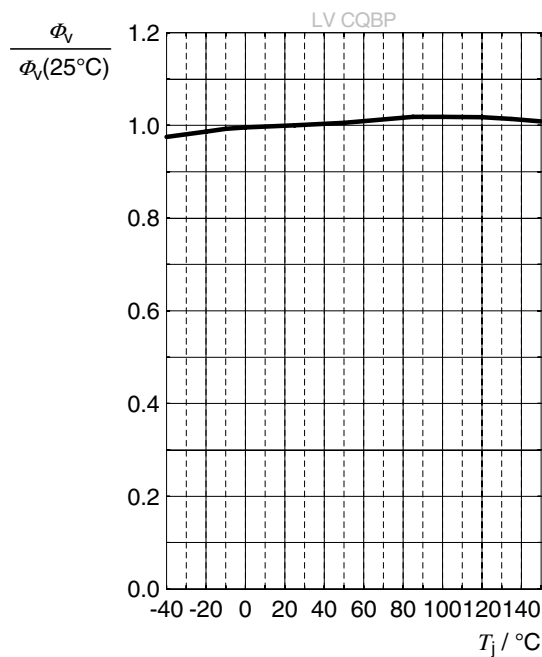
### Forward Voltage <sup>6)</sup>

$$\Delta V_F = V_F - V_F(25\text{ }^\circ\text{C}) = f(T_j); I_F = 350\text{ mA}$$



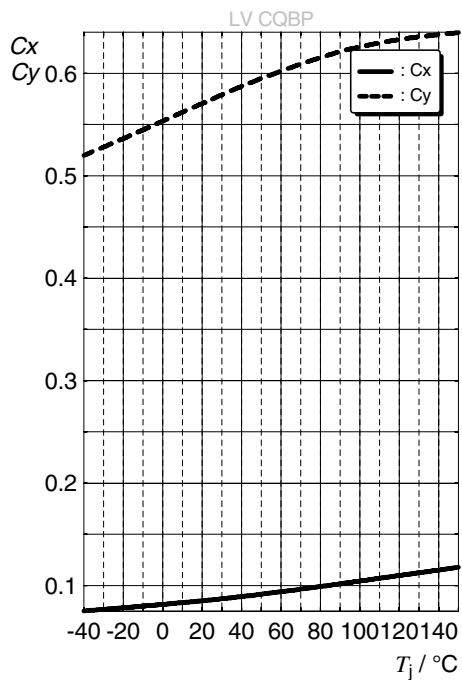
### Relative Luminous Flux <sup>6)</sup>

$$\Phi_v / \Phi_v(25\text{ }^\circ\text{C}) = f(T_j); I_F = 350\text{ mA}$$



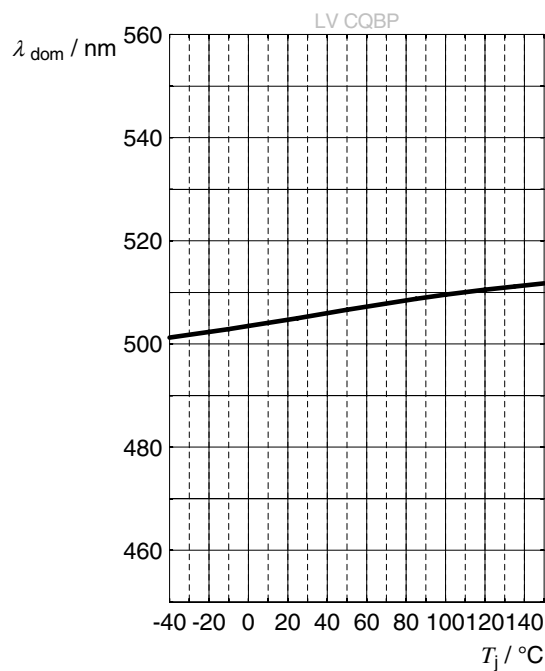
### Chromaticity Coordinate Shift <sup>6)</sup>

$$C_x, C_y = f(T_j); I_F = 350\text{ mA}$$



### Dominant Wavelength <sup>6)</sup>

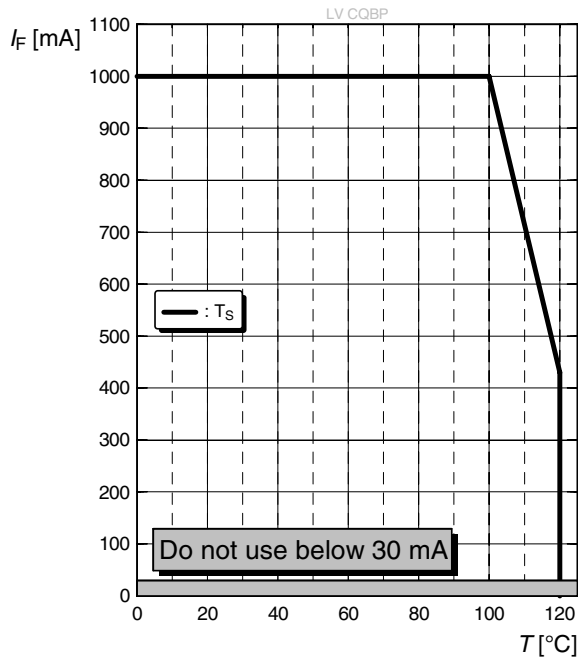
$$\lambda_{\text{dom}} = f(T_j); I_F = 350\text{ mA}$$



Not for new design

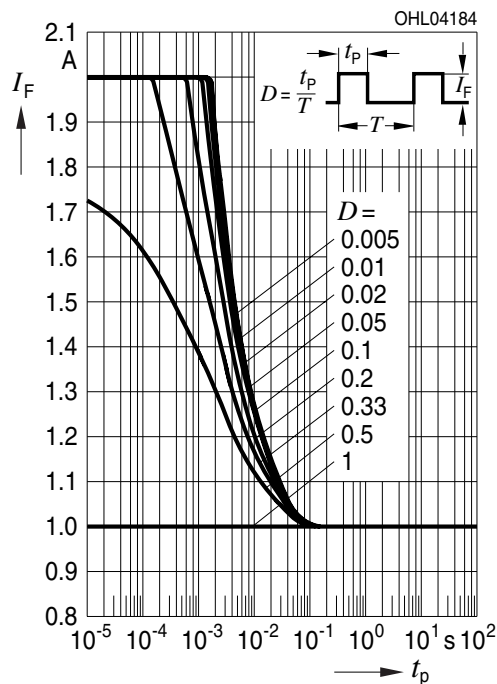
### Max. Permissible Forward Current

$I_F = f(T)$



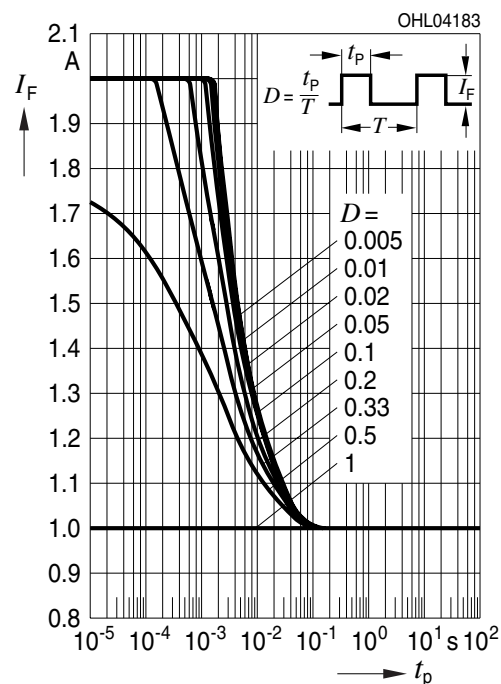
### Permissible Pulse Handling Capability

$I_F = f(t_p)$ ; D: Duty cycle;  $T_s = 25\text{ }^\circ\text{C}$



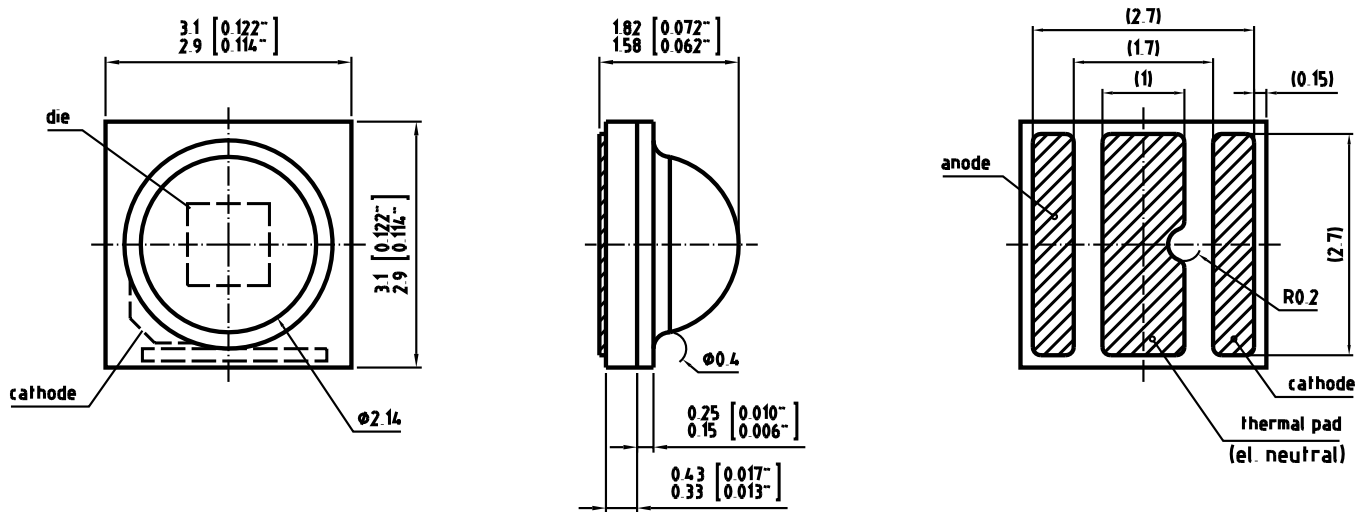
### Permissible Pulse Handling Capability

$I_F = f(t_p)$ ; D: Duty cycle;  $T_s = 85\text{ }^\circ\text{C}$



Not for new design

Dimensional Drawing <sup>9)</sup>



C63062-A4226-A20..-01

Further Information:

Approximate Weight: 25.0 mg

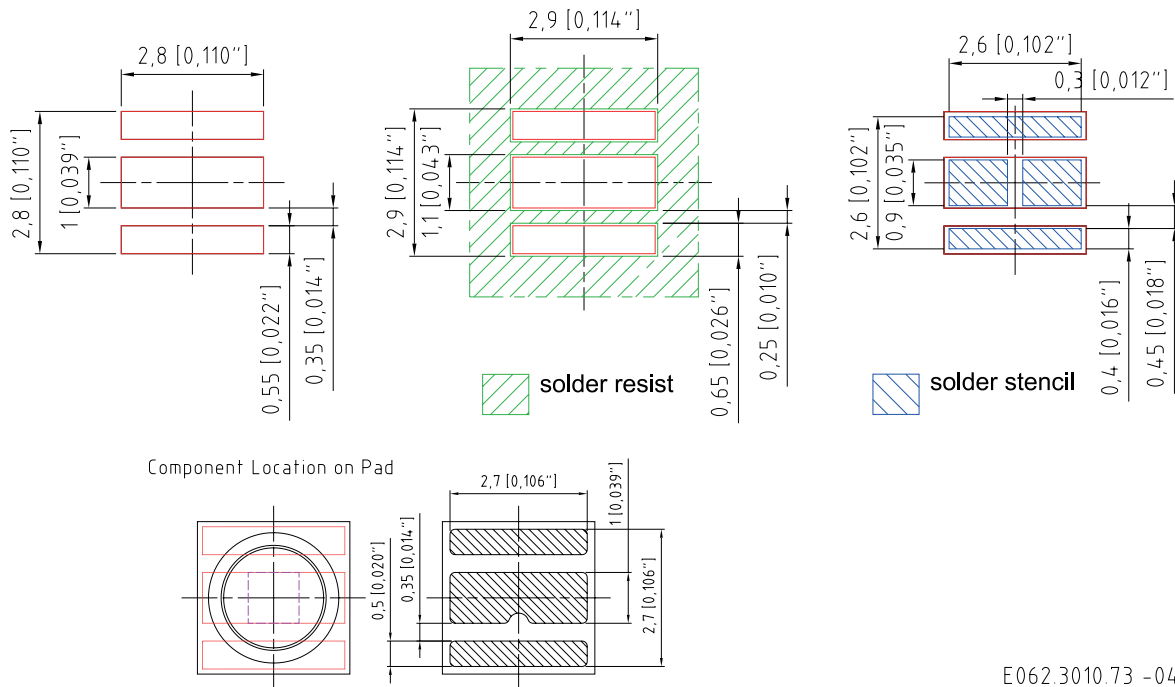
Package marking: Cathode

Corrosion test: Class: 3B  
 Test condition: 40°C / 90 % RH / 15 ppm H<sub>2</sub>S / 14 days (stricter than IEC 60068-2-43)

ESD advice: The device is protected by ESD device which is connected in parallel to the Chip.

Not for new design

## Recommended Solder Pad <sup>9)</sup>



E062.3010.73 -04

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.

## Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

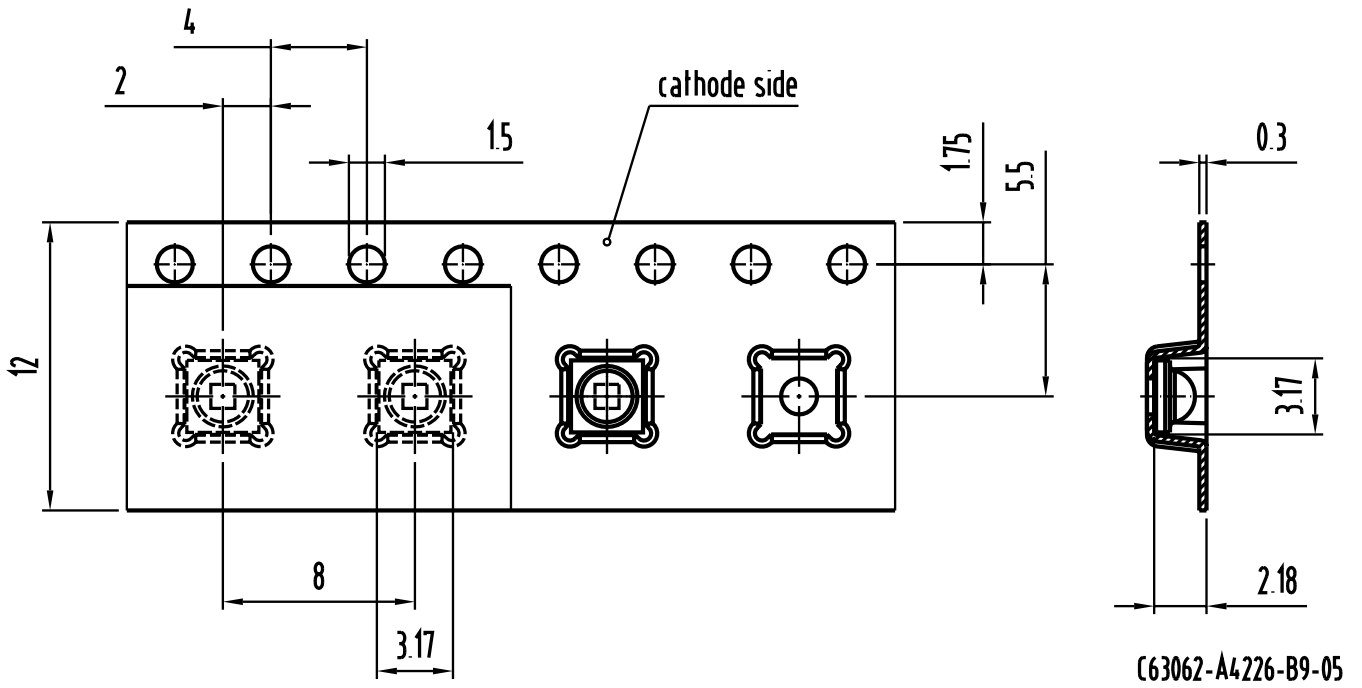


Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat <sup>*)</sup> 25 °C to 150 °C			2	3	K/s
Time $t_s$ $T_{Smin}$ to $T_{Smax}$	$t_s$	60	100	120	s
Ramp-up rate to peak <sup>*)</sup> $T_{Smax}$ to $T_p$			2	3	K/s
Liquidus temperature	$T_L$		217		°C
Time above liquidus temperature	$t_L$		80	100	s
Peak temperature	$T_p$		245	260	°C
Time within 5 °C of the specified peak temperature $T_p - 5$ K	$t_p$	10	20	30	s
Ramp-down rate* $T_p$ to 100 °C			3	6	K/s
Time 25 °C to $T_p$				480	s

All temperatures refer to the center of the package, measured on the top of the component  
 \*) slope calculation  $DT/Dt$ :  $Dt$  max. 5 s; fulfillment for the whole T-range

Not for new design

Taping <sup>9)</sup>



Not for new design

**Tape and Reel** <sup>10)</sup>



**Reel Dimensions**

A	W	$N_{min}$	$W_1$	$W_{2max}$	Pieces per PU
180 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	600

Not for new design

### Barcode-Product-Label (BPL)

**OSRAM Opto Semiconductors** LX XXXX BIN1: XX-XX-X-XXX-X

RoHS Compliant

(6P) BATCH NO: 1234567890 ML Temp ST  
X XXX °C X

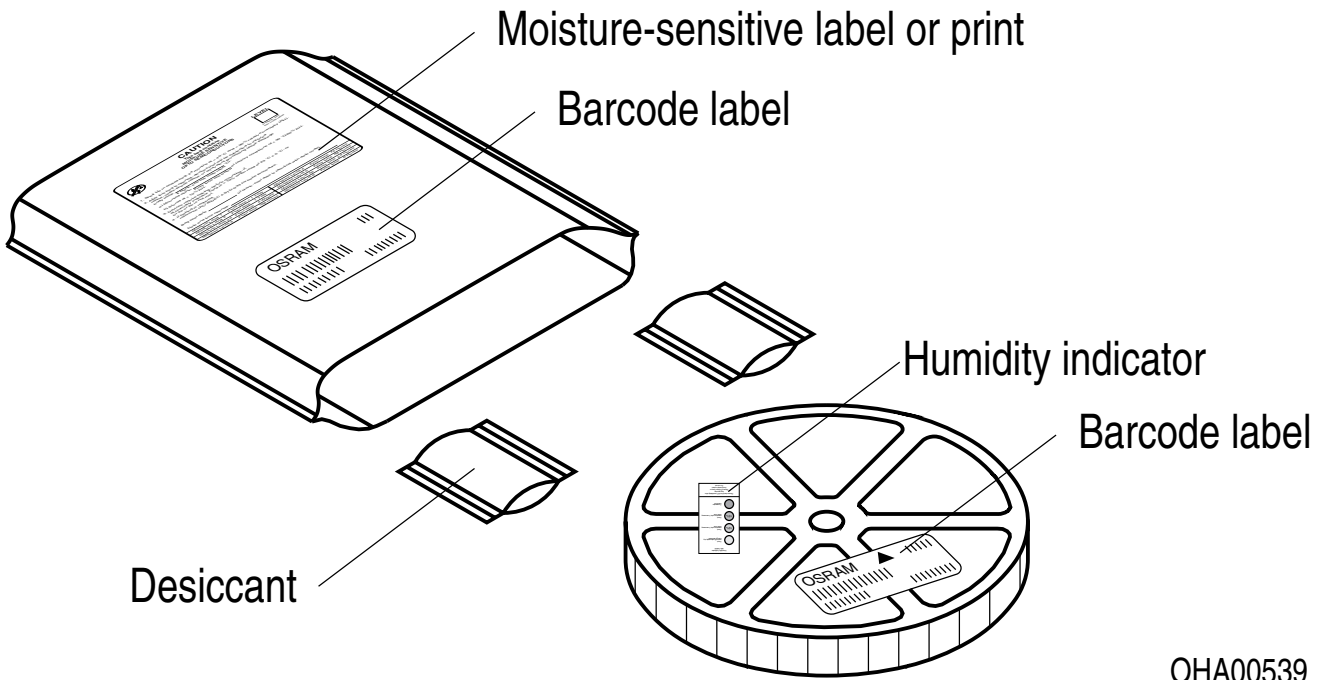
(1T) LOT NO: 1234567890 (9D) D/C: 1234 Pack: RXX  
DEMY XXX  
X\_X123\_1234.1234 X

(X) PROD NO: 123456789(Q)QTY: 9999 (G) GROUP: XX-XX-X-X

The diagram shows a rectangular label with rounded corners. It contains the OSRAM logo and product name at the top left. To the right are fields for 'LX XXXX' and 'BIN1: XX-XX-X-XXX-X'. Below the logo is 'RoHS Compliant'. The label features three horizontal barcode areas. The first is labeled '(6P) BATCH NO: 1234567890' and is accompanied by a 'No moisture' symbol and 'ML Temp ST X XXX °C X'. The second is labeled '(1T) LOT NO: 1234567890' and '(9D) D/C: 1234', with 'Pack: RXX', 'DEMY XXX', and 'X\_X123\_1234.1234 X' below it. The third is labeled '(X) PROD NO: 123456789(Q)QTY: 9999' and '(G) GROUP: XX-XX-X-X'. A QR code is located on the right side of the label.

OHA04563

### Dry Packing Process and Materials <sup>9)</sup>



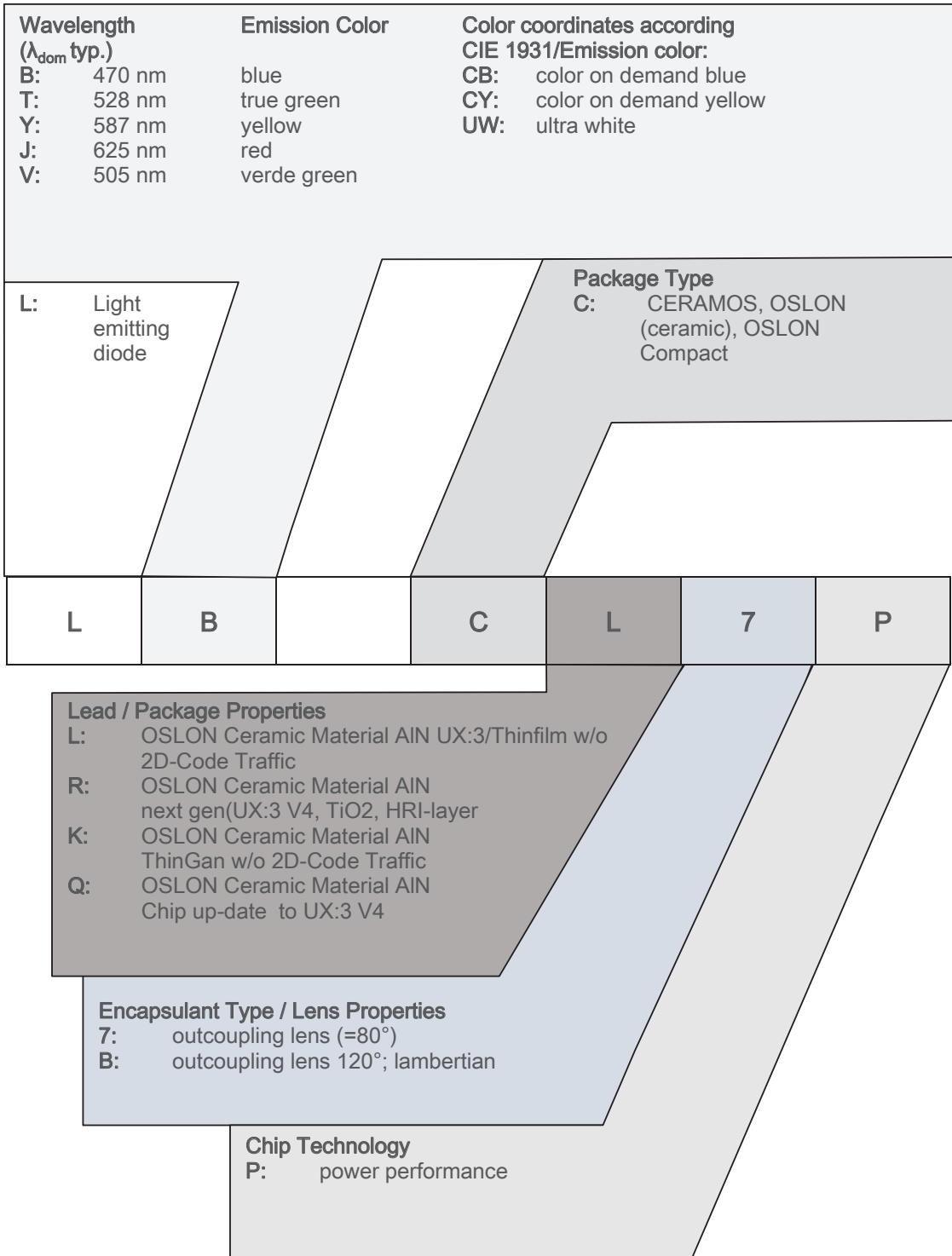
OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Not for new design



## Type Designation System



Not for new design

---

## Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **moderate risk (exposure time 0.25 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit [www.osram-os.com/appnotes](http://www.osram-os.com/appnotes)

## Disclaimer

### Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

### Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

### Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.

---

## Glossary

- 1) **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of  $\pm 8\%$  and an expanded uncertainty of  $\pm 11\%$  (acc. to GUM with a coverage factor of  $k = 3$ ).
- 2) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- 3) **Wavelength:** The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of  $\pm 0.5$  nm and an expanded uncertainty of  $\pm 1$  nm (acc. to GUM with a coverage factor of  $k = 3$ ).
- 4) **Forward Voltage:** The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of  $\pm 0.05$  V and an expanded uncertainty of  $\pm 0.1$  V (acc. to GUM with a coverage factor of  $k = 3$ ).
- 5) **Thermal Resistance:**  $R_{th\ max}$  is based on statistic values ( $6\sigma$ ).
- 6) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 7) **Chromaticity coordinate groups:** Chromaticity coordinates are measured during a current pulse of typically 25 ms, with an internal reproducibility of  $\pm 0.005$  and an expanded uncertainty of  $\pm 0.01$  (acc. to GUM with a coverage factor of  $k = 3$ ).
- 8) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 9) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with  $\pm 0.1$  and dimensions are specified in mm.
- 10) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

---

## Revision History

Version	Date	Change
1.6	2019-07-19	Features Further Information
1.7	2020-03-23	Schematic Transportation Box Dimensions of Transportation Box
1.8	2020-08-17	Not for new design

**Published by OSRAM Opto Semiconductors GmbH** EU RoHS and China RoHS compliant product  
**Leibnizstraße 4, D-93055 Regensburg**  
**www.osram-os.com © All Rights Reserved.**



此产品符合欧盟 RoHS 指令的要求；  
按照中国的相关法规和标准，不含有毒有害物质或元素。

单击下面可查看定价，库存，交付和生命周期等信息

[>>OSRAM\(欧司朗光电半导体\)](#)